





**40V HIGH CURRENT LOW LEAKAGE SCHOTTKY DIODE** 

#### Features

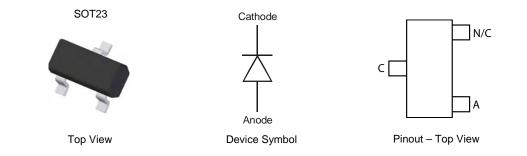
- Low Equivalent on Resistance
- Extremely Low Leakage (typically 6µA @30V)
- High current capability (I<sub>F</sub> = 1.16A)
- Low V<sub>F</sub>, Fast Switching Schottky
- SOT23 Package
- ZLLS1000 Complements Low Temperature Equivalent ZHCS1000
- Package Thermally Rated to +150°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOT23
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.008 grams (Approximate)

### **Applications**

- DC DC Converters
- Strobes
- Mobile Phones
- Charging Circuits
- Motor Control



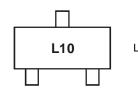
#### **Ordering Information**

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZLLS1000TA	L10	7	8	3,000 units
ZLLS1000TC	L10	13	8	10,000 units

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>

## **Marking Information**



L10 = Product type Marking Code





## ZLLS1000

#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

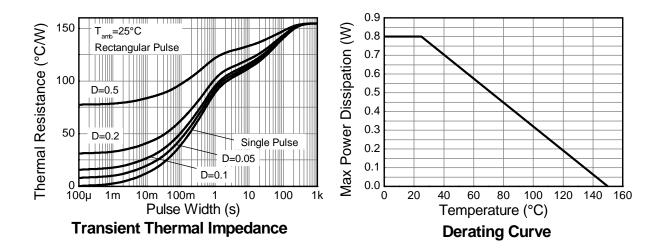
Characteristic		Symbol	Value	Unit
Continuous Reverse Voltage		VR	40	V
Forward Current		IF	1.16	А
Peak Repetitive Forward Current Rectangular Pulse Duty Cycle 50% 100µs pulse width		I <sub>FPK</sub>	2.6	A
Non Repetitive Forward Current	t≤100µs t≤10ms	I <sub>FSM</sub>	22 6.4	A A

## **Thermal Characteristics**

Charao	Symbol	Value	Unit	
Power Dissipation @T <sub>A</sub> = +25°C	Single Die Continuous Single Die Measured at t<5 secs	PD	0.8 1.18	W
Thermal Resistance Junction to Ambient (Note 4)		R <sub>θJA</sub>	155	°C/W
Thermal Resistance Junction to Ambient (Note 5)		R <sub>0JA</sub>	106	°C/W
Thermal Resistance Junction to Lead (Solder Point)		R <sub>θJL</sub>	80	°C/W
Storage temperature range		T <sub>STG</sub>	-55 to +150	°C
Junction temperature	TJ	150	°C	

Notes: 4. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions. 5. For a device mounted on FRB PCB measured at t<5secs.

## Thermal Characteristics and Derating information







**ZLLS1000** 

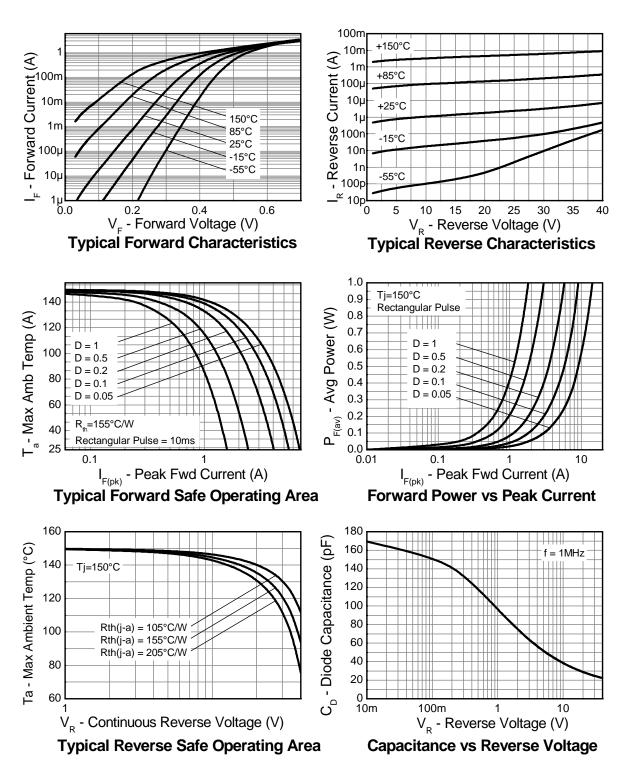
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse breakdown voltage	V <sub>(BR)R</sub>	40	-	-	V	$I_R = 500 \mu A$
		-	320	355	mV	$I_F = 50 \text{mA}$
			335	380		I <sub>F</sub> = 100mA
			380	425		I <sub>F</sub> = 250mA
Forward voltage (Note 6)	VF		410	460		$I_F = 500 \text{mA}$
	VF		440	510		I <sub>F</sub> = 750mA
			470	560		$I_F = 1A$
			530	660		I <sub>F</sub> = 1.5A
			430	-		$I_F = 1000 \text{mA}, T_A = +100^{\circ}\text{C}$
Reverse current	1-	-	5	20	μA	$V_R = 30V$
	I <sub>R</sub>		500	-	μA	$V_R = 30V, T_A = +85^{\circ}C$
Diode capacitance	CD	-	28	-	pF	$f = 1MHz, V_R = 30V$
Reverse recovery time Reverse recovery charge	t <sub>rr</sub> Q <sub>rr</sub>	-	5 350	-	ns nC	Switched from I <sub>F</sub> = 500mA to V <sub>R</sub> = 5.5V Measured @ I <sub>R</sub> 50mA. di /dt = 500mA/ ns. R <sub>source</sub> = 6 $\Omega$ ; R <sub>load</sub> = 10 $\Omega$

Notes: 6. Measured under pulsed conditions. Pulse width = 300µs. Duty cycle < 2%



A Product Line of Diodes Incorporated



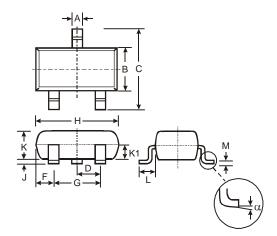






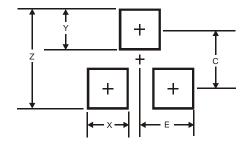


# Package Outline Dimensions



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
в	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
К	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All	All Dimensions in mm				

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35





# ZLLS1000

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